

A T 2 4 C 3 2 E - S S H M x x - T

Product Family

24C = Standard I²C-compatible
Serial EEPROM

Device Density

32 = 32 Kilobit

Device Revision

Shipping Carrier Option

T = Tape and Reel, Standard Quantity Option
E = Tape and Reel, Extended Quantity Option
B = Bulk (Tubes)

Product Variation

xx = Applies to select packages only.

Operating Voltage

M = 1.7V to 3.6V

**Device Grade or
Wafer/Die Thickness**

H or U = Industrial Temperature Range
(-40°C to +85°C)

11 = 11mil Wafer Thickness

Package Option

SS = SOIC
X = TSSOP
MA = 2.0mm x 3.0mm UDFN
P = PDIP
ST = SOT23
C = VFBGA
U1 = 2x2 Grid, 4-ball WLCSP
WWU = Wafer Unsawn